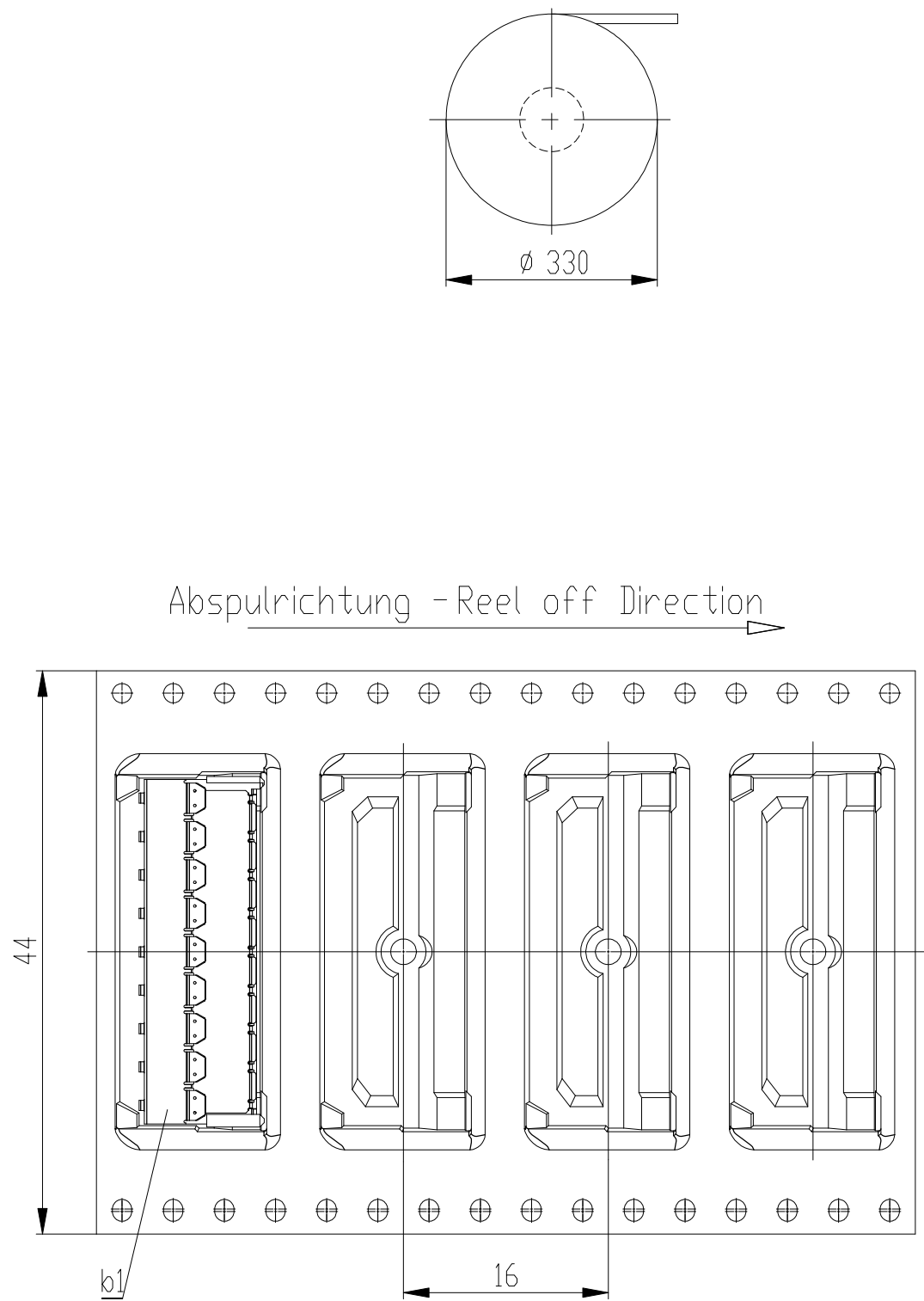
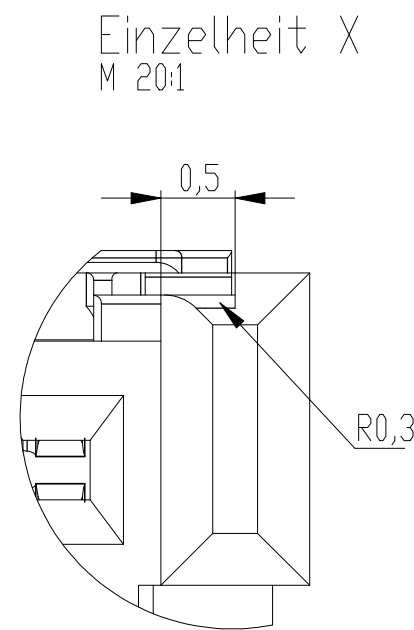
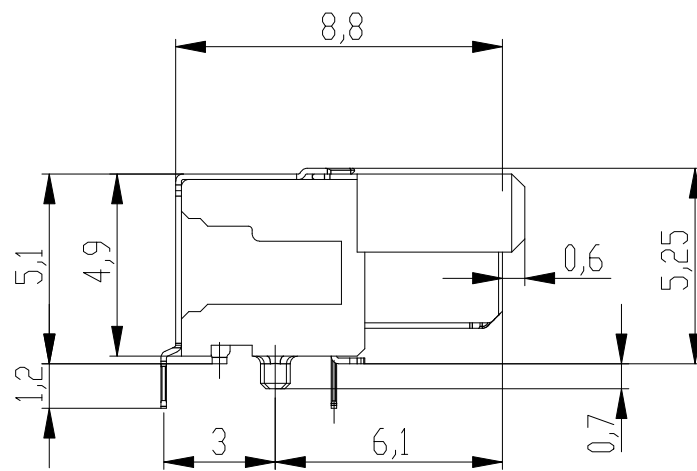
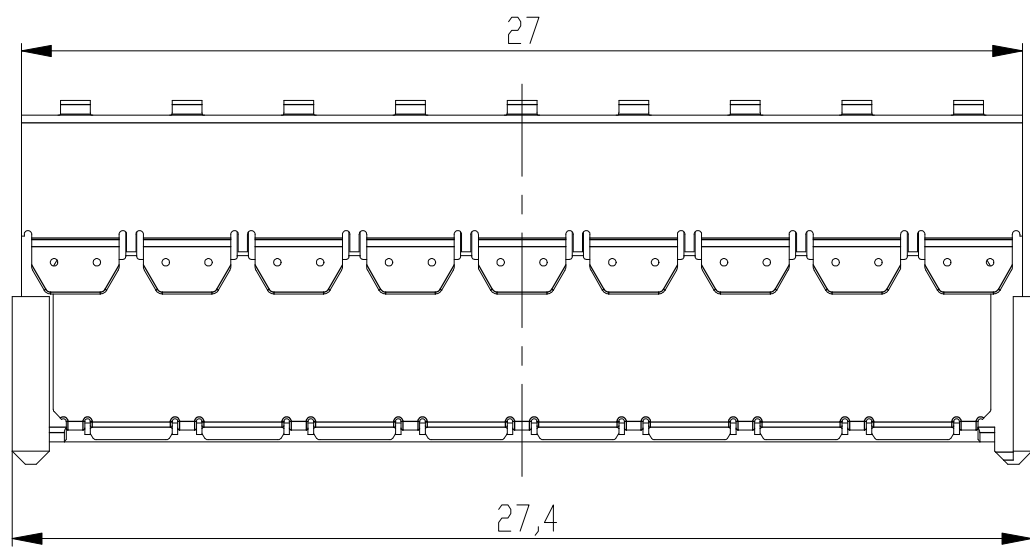
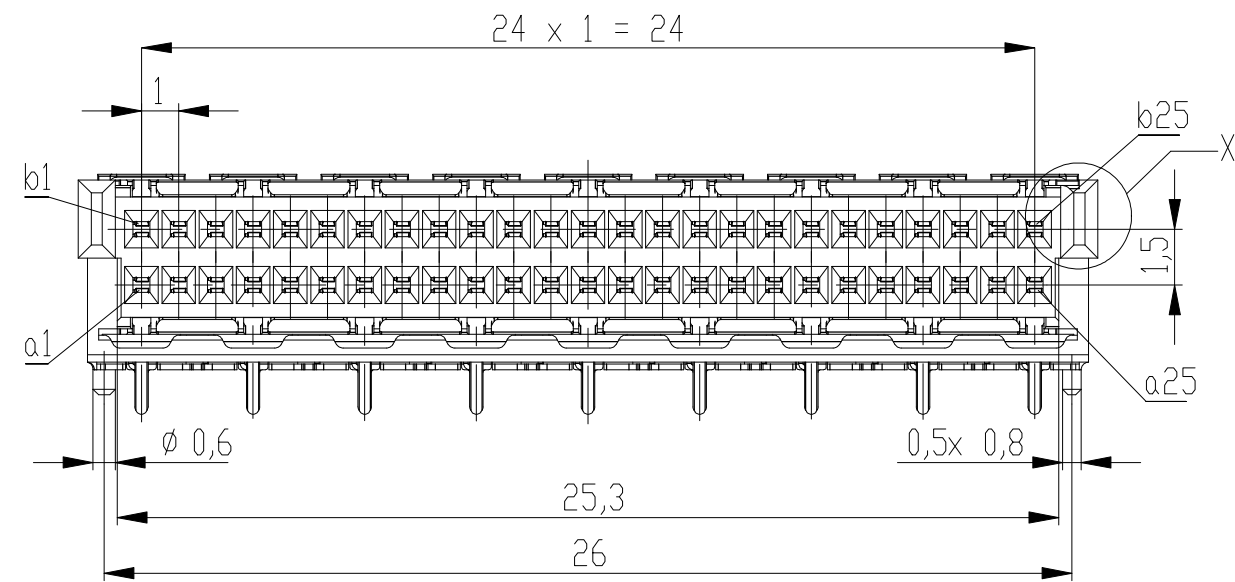
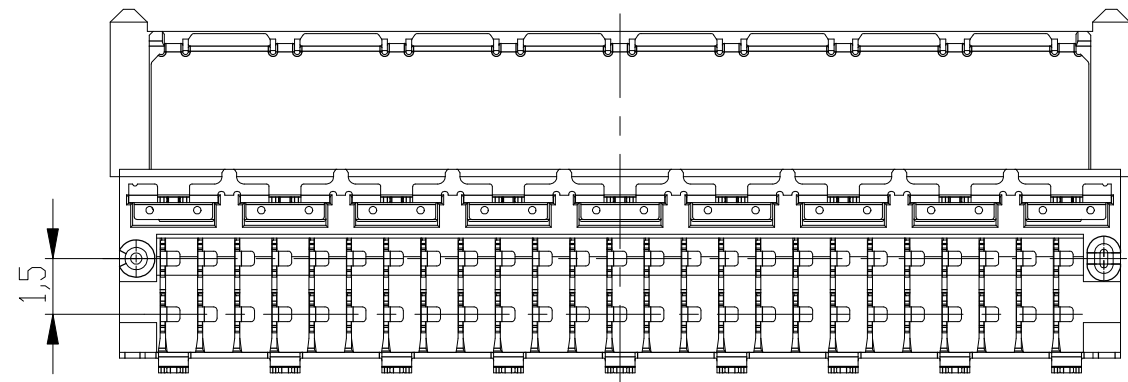
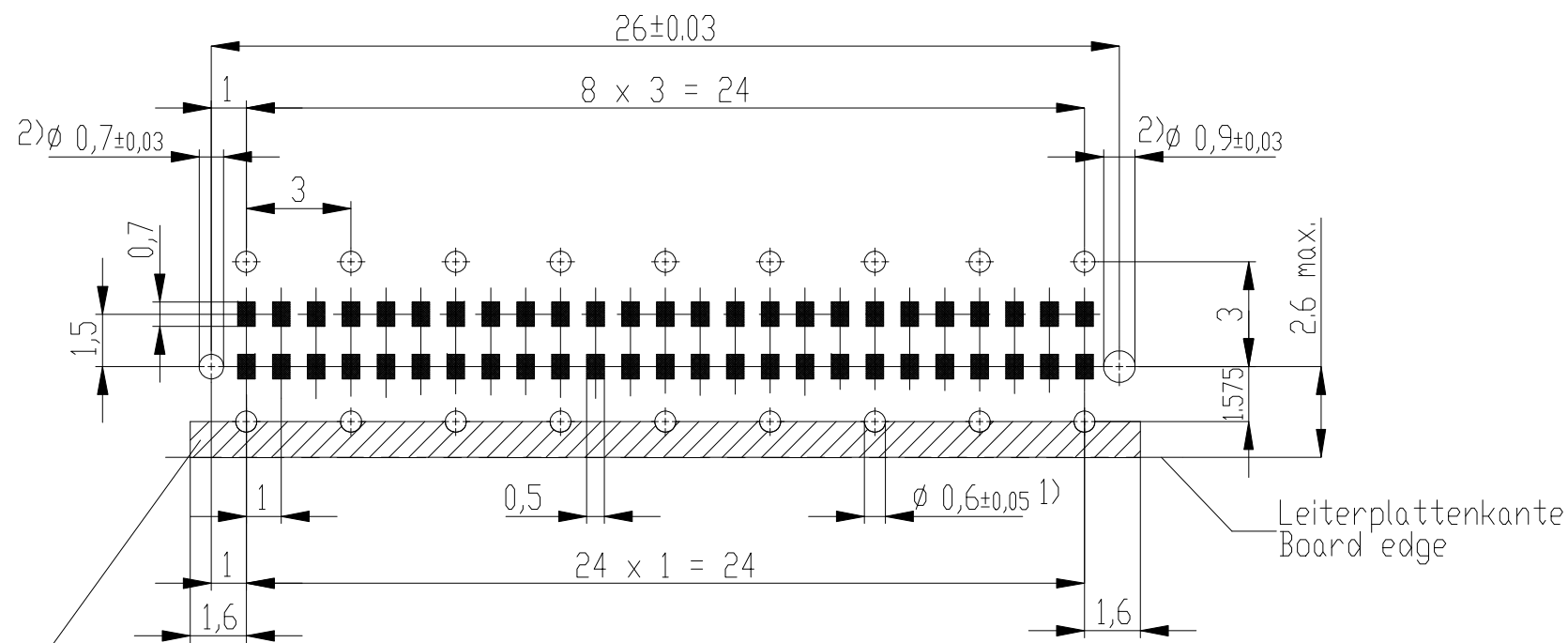


Verpackt im Gurt in Anlehnung an DIN IEC 60286-3
Tape on Reel Packaging according to DIN IEC 60286-3
Verpackungseinheit: 500 Stück
Packaging unit: 500 pcs



Leiterplatten-Layout Vorschlag / PCB-layout proposal



Schirmblechauflagefläche berücksichtigen,
keine Durchkontaktierungen oder Leitungen möglich!
Consider shielding contact area, no via's or traces possible!

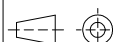
1) Fertiglochdurchmesser / Finished Via diameter
2) Durchmesser des Bohrers / Drill tool

Anforderungsstufe 1
Performance Level 1

Kontaktbereich vergoldet
Mating Area gold plating

Anschlussbereich verzinkt 4-6 µm
Terminal Area 4-6 µm tin plating

Koplanarität der Anschlüsse ≤ 0,1 mm
Coplanarity Area of Termination ≤ 0,1 mm

Information:			Tolerances		Scale 5:1	
			 All Dimensions in mm			
Customer drawing:			Subject to modification without prior notice. Drawing will not be updated.		Designation	
THIS DRAWING IS A CONTROLLED DOCUMENT.					ERNI-Federl. 90° SMDTHR 50p. BM EMV Female 90° SMDTHR 50co. BM EMV	
			 TE Connectivity		C- 374720-E	
					I A2	
g					Class	
Index			Date		MSPEED	

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